### SUM110P04-04L



**Vishay Siliconix** 

## P-Channel 40 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>d</sup>			
-40	0.0042 at $V_{GS}$ = -10 V	-110			
-40	0.0062 at $V_{GS}$ = -4.5 V	-110			

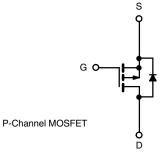
# TO-263 D G Top View

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- Low thermal resistance
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912







#### **Ordering Information:**

SUM110P04-04L-E3 (Lead (Pb)-free)

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V <sub>DS</sub>	-40	V			
Gate-Source Voltage	V <sub>GS</sub>	± 20	V			
Continuous Drain Current (T <sub>1</sub> = 175 °C) <sup>d</sup>	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	-110	A		
Continuous Drain Current $(1) = 175$ C) °	T <sub>C</sub> = 125 °C		-110			
Pulsed Drain Current	I <sub>DM</sub>	-240	А			
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	-75			
Single Pulse Avalanche Energy <sup>a</sup>		E <sub>AS</sub>	281	mJ		
Power Dissipation	T <sub>C</sub> = 25 °C	Pn	375 <sup>c</sup>	w		
Fower Dissipation	T <sub>A</sub> = 25 °C <sup>b</sup>	۳D	3.75			
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 175	°C		

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-Ambient PCB Mount <sup>b</sup>	R <sub>thJA</sub>	40	°C/W		
Junction-to-Case	R <sub>thJC</sub>	0.4	0/10		

#### Notes

- a. Duty cycle  $\leq 1$  %.
- b. When mounted on 1" square PCB (FR-4 material).
- c. See SOA curve for voltage derating.

d. Limited by package.

1

### SUM110P04-04L



www.vishay.com

Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-40			V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-1		-3		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}=0~V,~V_{GS}=\pm~20~V$			± 100	nA	
		$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-1	μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = -40 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			-50		
		$V_{DS}$ = -40 V, $V_{GS}$ = 0 V, $T_{J}$ = 175 °C			-250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 V, V_{GS} = -10 V$	-120			А	
		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -30 \text{ A}$		0.0034	0.0042		
Drain-Source On-State Resistance <sup>a</sup>	P	$V_{GS}$ = -10 V, $I_D$ = -30 A, $T_J$ = 125 $^\circ C$			0.0063		
Drain-Source On-State Resistance ~	R <sub>DS(on)</sub>	$V_{GS}$ = -10 V, $I_D$ = -30 A, $T_J$ = 175 °C			0.0076	Ω	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -20 \text{ A}$		0.005	0.0062		
Forward Transconductance <sup>a</sup>	<b>g</b> fs	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -30 A	20			S	
Dynamic <sup>b</sup>							
Input Capacitance	Ciss			11 200		pF	
Output Capacitance	Coss	$V_{GS} = 0 V$ , $V_{DS} = -25 V$ , f = 1 MHz		1650			
Reverse Transfer Capacitance	C <sub>rss</sub>			1200			
Total Gate Charge <sup>c</sup>	Qg			235	350	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -110 \text{ A}$		45			
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			65			
Gate Resistance	Rg			3		Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			25	40	ns	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = -20 \text{ V}, \text{ R}_{\text{L}} = 0.18 \Omega$		30	45		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D\cong$ -110 A, $V_{GEN}$ = -10 V, $R_g$ = 2.5 $\Omega$		190	300		
Fall Time <sup>c</sup>	t <sub>f</sub>	] [		110	165		
Source-Drain Diode Ratings and Cha	aracteristics	(T <sub>C</sub> = 25 °C) <sup>b</sup>					
Continuous Current	ا <sub>S</sub>				-110	^	
Pulsed Current	I <sub>SM</sub>				-240	A	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = -85 A, V <sub>GS</sub> = 0 V		-1	-1.5	V	
Reverse Recovery Time	t <sub>rr</sub>			65	100	ns	
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = -85 A, dl/dt = 100 A/μs		-3.7	-5.6	А	
Reverse Recovery Charge	Q <sub>rr</sub>	1		0.12	0.28	μC	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

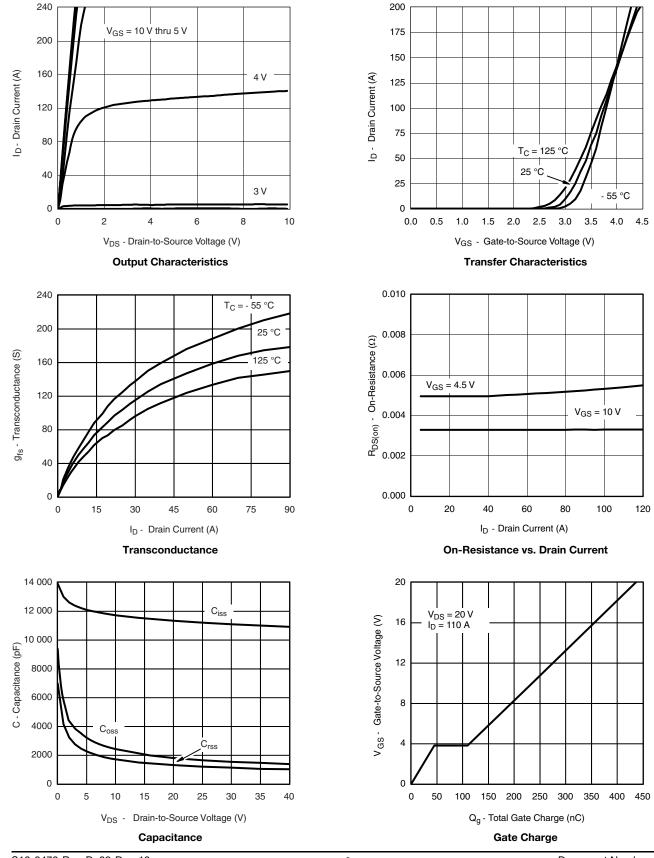
For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



SUM110P04-04L

**Vishay Siliconix** 

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



S13-2478-Rev. D, 09-Dec-13

Document Number: 72437

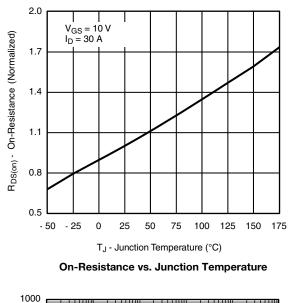
For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

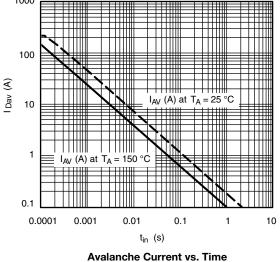


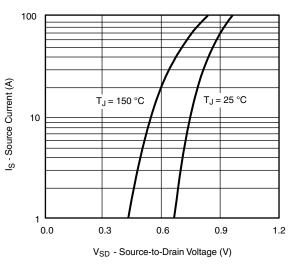


**Vishay Siliconix** 

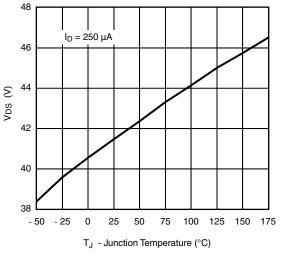
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Source-Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature

4

For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?72437.

### THERMAL RATINGS

300

250

200

150

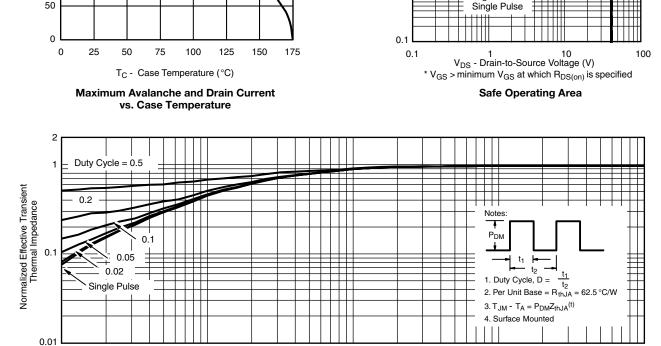
100

50

10-4

Downloaded from Arrow.com.

I<sub>D</sub> - Drain Current (A)



Square Wave Pulse Duration (s)

10<sup>-3</sup>

Normalized Thermal Transient Impedance, Junction-to-Case

10<sup>-2</sup>

1000

100

10

1

ID - Drain Current (A)

Limited by R<sub>DS(on)</sub>

T<sub>C</sub> = 25 °C

10-1

# SUM110P04-04L

**Vishay Siliconix** 

10 µs nin 100 µs

1 ms

10 ms 100 ms DCIIII

1



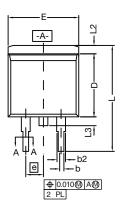
Limited

by Package



**Vishay Siliconix** 

TO-263 (D<sup>2</sup>PAK): 3-LEAD









DETAIL A (ROTATED 90°)



		INC	HES	MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
А		0.160	0.190	4.064	4.826	
b		0.020	0.039	0.508	0.990	
b1		0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
c2		0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
D1		0.220	0.240	5.588	6.096	
D2		0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
D4		0.044	0.052	1.118	1.321	
	E	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
E2		0.355	0.375	9.017	9.525	
E3		0.072	0.078	1.829	1.981	
	е	0.100	) BSC	2.54 BSC		
K		0.045	0.055	1.143	1.397	
L		0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
L2		0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
	L4	0.010 BSC		0.254 BSC		
	М	-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843						

#### Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 % of L1 can fall above seating plane by
- max. 8 mils. 3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB.
  - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

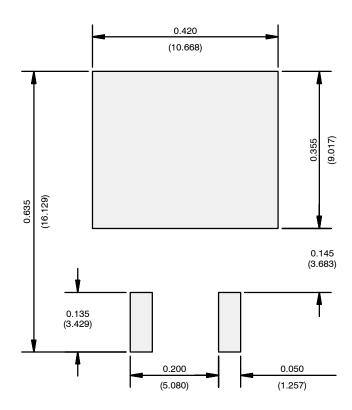
6. This feature is for thick lead.

Revison: 30-Sep-13

1



### **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

### Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.